



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kenneth P. Rodbell

Group Art Unit: 1753

Serial No.: 10/055,134

Examiner: Phasge, Arun S.

Jan. 22, 2002 Filed:

In Response to Office Action

Dated:

May 4, 2004

For:

Method For Plating Copper Conductors and Devices Formed

Attorney Docket No.: 64,610-043A (Y0998-503)

Certificate of Mailing

I hereby certify that this paper (alcattached or enclosed) is being deposit with any referred to as being with the United States Postal Service on the date shown below eient postage as first class mail in an envelope addressed to: Alexandria, VA 22313-1450. Patents, P.O. Box 1450,

Date: Aug. 4, 2004

## RESPONSE TO OFFICE ACTION

Commissioner for Patents Alexandria, VA 22313-1450

Dear Sir:

In response to an Office Action mailed May 4, 2004, please consider the following remarks.